## 502123965 11/09/2012

### PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

#### **CONVEYING PARTY DATA**

Name	Execution Date
Daisuke CHIKAMORI	09/19/2012
Yasuhiko NISHIO	09/14/2012
Naoki YUTANI	09/14/2012

### **RECEIVING PARTY DATA**

Name:	MITSUBISHI ELECTRIC CORPORATION	
Street Address:	7-3, Marunouchi 2-chome, Chiyoda-ku	
City:	Tokyo	
State/Country:	JAPAN	
Postal Code:	100-8310	

### PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	13673349	

## **CORRESPONDENCE DATA**

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NAME OF SUBMITTER:	Donald R. Studebaker	

Total Attachments: 1 source=ASN#page1.tif

PATENT

REEL: 029272 FRAME: 0614

JP \$40.00 136/334

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# ASSIGNMENT OF APPLICATION FOR UNITED STATES LETTERS PATENT

WHEREAS Daisuke CHIK				all of c/o Mitsubishi		
Electric Corporation, 7-3, Marunouchi 2-chome, Chiyoda-ku, Tokyo 1008310,Japan hereinafter referred to collectively as the assignor, has invented a certain improvement relating to:						
METHOD OF MANUFACTURING SILIC	ON CARBIDE	SEMICONDL	ICTOR DEVICE			
[X] the inventor(s) declaration for said application being executed concurrently with the execution of this instrument; said application to be filed in the United States Patent and Trademark Office;						
[ ] said application having been filed in the United States Patent and Trademark Office on, authorization being hereby given to the practitioners associated with STUDEBAKER & BRACKETT PC's CUSTOMER NUMBER 78198, to insert here in parentheses (Application Serial No) the application serial number of said application when known;						
[ ] said application having been filed und Serial No.				, äs <u></u> ,		
AND WHEREAS Mitsubishing Tokyo 1008310, Japan is desirous of acquiring the entire right divisions and continuations thereof, and therefor, including any and all renewals,	t, title and inte in and to said i	rest in and to	_, hereinafter referr o said application, any and all patents	ed to as the assignee, including any and all		
NOW, that for and in consideration of One Dollar (\$1.00), and other good and valuable consideration paid by said assignee to said assignor, the receipt of which is hereby acknowledged, said assignor hereby assigns, sells and transfers to said assignee, and said assignee's successors and assigns, the full and exclusive right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof; said assignee, and said assignee's successors and assigns, to have, hold, exercise and enjoy the said application, including any and all divisions and continuations thereof, and the said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such patents when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said assignee, and said assignee's successors and assigns, in as ample and beneficial a manner as the said assignor might or could have held and enjoyed the same, if this assignment had not been made.						
AND said assignor hereby agrees to perform, upon the request of said assignee, or said assignee's successors or assigns, any and all acts relating to the obtaining or to the asserting of said patents, including any and all renewals, reissues and prolongations thereof.						
AND said assignor authorizes a Letters Patent on said application, and o said assignee's successors and assigns	n any and all di	visions and co				
The undersigned hereby grant(s on this Assignment any further identifica rules of the U.S. Patent and Trademark	ition which ma	y be necessar	y or desirable in or			
This Assignment has been exenume(s).	ecuted by the	undersigned (	on the date(s) opp	osite the undersigned		
Date: September. 19 20/2	Signature:	<u>Dairuke</u> Daisuke CHII	Chikamori/ KAMORI			
Date: September 14 2012	Signature: Name:	Jasul Vasuhiko NIS	ika Tishu shlo	· 2		
Date: Soptember 14, 2012	Signature:	Mold Gul	o Con j			

PATENT REEL: 029272 FRAME: 0615

**RECORDED: 11/09/2012**